

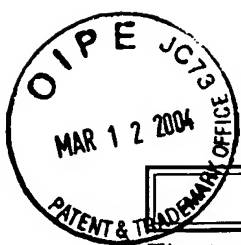
Electronic Filing System (EFS) Data
Electronic Patent Application Submission
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EFS ID: 57018
Application ID: 10706468
Title of Invention: SEMICONDUCTOR PACKAGE
WITH CHAMFERED CORNERS
AND METHOD OF
MANUFACTURING THE SAME
First Named Inventor: Sung Yang
Domestic/Foreign Application: Domestic Application
Filing Date: 2003-11-12
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Statement
Filing Type:
Confirmation number: 6744
Attorney Docket Number: AMKOR095A



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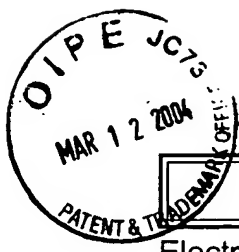


TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	SEMICONDUCTOR PACKAGE WITH CHAMFERED CORNERS AND METHOD OF MANUFACTURING THE SAME									
Application Number: 10/706468 										
Date: 2003-11-12										
First Named Applicant: Sung Jin Yang										
Confirmation Number: 6744										
Attorney Docket Number: AMKOR095A										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Mark B. Garred Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Mark B. Garred Registered Number: 34,823	/mbg/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
Mark B. Garred Registered Number: 34,823	/mbg/	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids4-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	ids4-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
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	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of
Invention

SEMICONDUCTOR PACKAGE WITH CHAMFERED
CORNERS AND METHOD OF MANUFACTURING THE
SAME

Application Number: 10/706468
Confirmation Number: 6744
First Named Applicant: Sung Yang
Attorney Docket Number: AMKOR095A
Art Unit: 2811

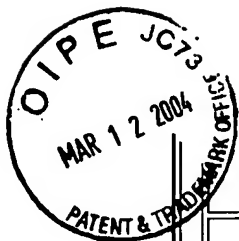


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or 5977613 or 5976912 or 5981314 or 5986885
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or 6020625 or 6025640 or 6031279 or 6034423
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or 6184573 or 6184465).pn.

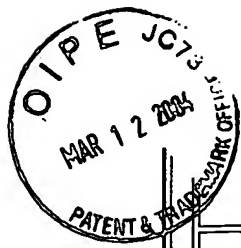
US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	5903049	1999-05-11	MORI			
	2	5909053	1999-06-01	FUKASE ET AL.			
	3	5917242	1999-06-29	BALL			
	4	5915998	1999-06-29	STIDHAM ET AL.			
	5	5939779	1999-08-17	KIM			
	6	5942794	1999-08-24	OKUMURA ET AL.			
	7	5951305	1999-09-14	HABA			
	8	5959356	1999-09-28	OH			



9	5969426	1999-10-19	BABA ET AL.
10	5973388	1999-10-26	CHEW ET AL.
11	5977630	1999-11-02	WOODWORTH ET AL.
12	5977615	1999-11-02	YAMAGUCHI ET AL.
13	5977613	1999-11-02	TAKATA ET AL.
14	5976912	1999-11-02	FUKUTOMI ET AL.
15	5981314	1999-11-09	GLENN ET AL.
16	5986885	1999-11-16	WYLAND
17	5986333	1999-11-16	NAKAMURA
18	6001671	1999-12-14	FJELSTAD
19	6013947	2000-01-11	LIM
20	6018189	2000-01-25	MIZUNO
21	6020625	2000-02-01	QIN ET AL.
22	6025640	2000-02-15	YAGI ET AL.
23	6031279	2000-02-29	LENZ
24	6034423	2000-03-07	MOSTAFAZADEH
25	RE36613	2000-03-14	BALL
26	6040626	2000-03-21	CHEAH ET AL.
27	6043430	2000-03-28	CHUN
28	6060769	2000-05-09	WARK
29	6060768	2000-05-09	HAYASHIDA ET AL.
30	6072228	2000-06-06	HINKLE ET AL.
31	6075284	2000-06-13	CHOI ET AL.
32	6081029	2000-06-27	YAMAGUCHI
33	6084310	2000-07-04	MIZUNO ET AL.
34	6087722	2000-07-11	LEE ET AL.
35	6087715	2000-07-11	SAWADA ET AL.
36	6100594	2000-08-08	FUKUI ET AL.
37	6113474	2000-09-05	COSTANTINI ET AL.
38	6118184	2000-09-12	ISHIO ET AL.
39	6118174	2000-09-12	KIM
40	RE36907	2000-10-10	TEMPLETON, JR ET AL.
41	6130473	2000-10-10	MOSTAFAZADEH ET AL.
42	6130115	2000-10-10	OKUMURA ET AL.
43	6133623	2000-10-17	OTSUKI ET AL.
44	6140154	2000-10-31	HINKLE ET AL.



	45	6143981	2000-11-07	GLENN
	46	6169329	2001-01-02	FARNWORTH ET AL
	47	6177718	2001-01-23	KOZONO
	48	6181002	2001-01-30	JUSO ET AL
	49	6184573	2001-02-06	PU
	50	6184465	2001-02-06	CORISIS

Signature

Examiner Name	Date